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10/758,741

Jim L. Woods, Wayne G. Soderfelt (ExcelStore)

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U.S. PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
TC	5,452,157	09/19/1995	Chow et al.			
TC	5,555,144	09/10/1996	Wood et al.			
TC	5,615,067	03/25/1997	Jabbari et al.			
TC	5,982,581	11/09/1999	Kazmierczak et al.			
TC	US 6,370,100 B2	04/09/2002	Koshino et al.			
TC	US 6,414,817 B1	07/02/2002	Luo et al.			
TC	US 6,462,902 B1	10/08/2002	Luo et al.			
TC	US 6,462,903 B1	10/08/2002	Yamada et al.			
TC	US 2001/0017835 A1	08/30/2001	Koshino et al.			
TC	US 2003/0095497 A1	05/22/2003	Myrtle			

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

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/	US 2003/0179191 A1	09/25/2003	Matsuda et al.			
(not relevant)						

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